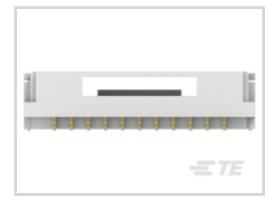


#### HPI

TE Internal #: 3-2390136-1 HPI, PCB Mount Header, Wire-to-Board, 11 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal, Natural

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 11

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in]

Termination Method to Printed Circuit Board: Surface Mount

### Features

#### **Product Type Features**

Connector System

Header Type

Wire-to-Board

Fully Shrouded



Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	11
Number of Rows	1
Electrical Characteristics	
Termination Resistance	20 mΩ
Insulation Resistance	100 MΩ
Dielectric Withstanding Voltage (Max)	500 V
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Layout	Staggered

HPI, PCB Mount Header, Wire-to-Board, 11 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal, Natural



Contact Underplating Material Thickness	1.27 – 2.7 μm[50 – 106 μin]
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Brass
Contact Mating Area Plating Material	Gold Flash
Contact Type	Pin
Contact Current Rating (Max)	1 A
Fermination Features	
Termination Method to Printed Circuit Board	Surface Mount
Aechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Solder Peg
Mating Retention Type	Latch
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
Housing Features	
Mating Entry Location	Side
Housing Material	LCP
Centerline (Pitch)	1.25 mm[.049 in]
Jsage Conditions	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Power & Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1500
Packaging Type	Carton, Reel

HPI, PCB Mount Header, Wire-to-Board, 11 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal, Natural



# Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JUL 2021 (219) SVHC > Threshold: Pb (4% in Component Part) Aticle Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

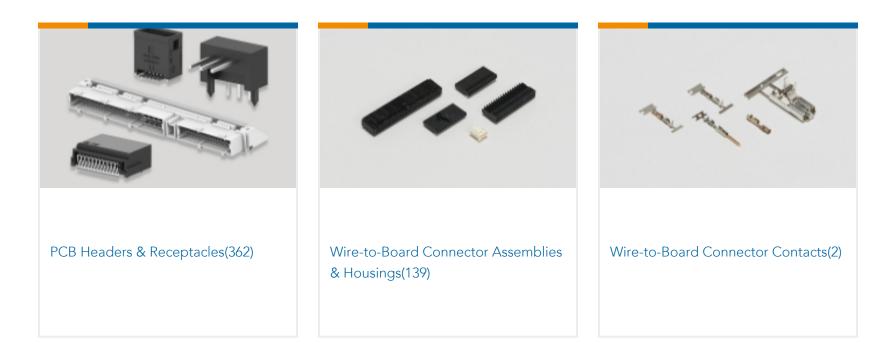
### **Compatible Parts**



### Also in the Series | HPI

HPI, PCB Mount Header, Wire-to-Board, 11 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal, Natural





## Customers Also Bought



RECP ASSY

RECP ASSY



### Documents

Product Drawings 1.25P 11POS WTB R/A BRD W LATCH AU NA

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_3-2390136-1\_1.2d\_dxf.zip

HPI, PCB Mount Header, Wire-to-Board, 11 Position, .049 in [1.25 mm] Centerline, Fully Shrouded, Gold Flash, Surface Mount, Power & Signal, Natural



English Customer View Model ENG\_CVM\_CVM\_3-2390136-1\_1.3d\_igs.zip English Customer View Model ENG\_CVM\_CVM\_3-2390136-1\_1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English